muRata

Reference Specification

Leaded MLCC for General Purpose RDE Series

Product specifications in this catalog are as of Dec. 2017, and are subject to change or obsolescence without notice.

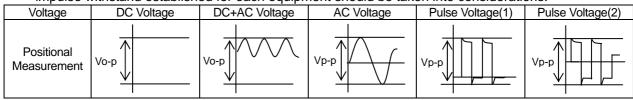
Please consult the approval sheet before ordering.Please read rating and Cautions first.

▲ CAUTION

1. OPERATING VOLTAGE

When DC-rated capacitors are to be used in AC or ripple current circuits, be sure to maintain the Vp-p value of the applied voltage or the Vo-p which contains DC bias within the rated voltage range. When the voltage is started to apply to the circuit or it is stopped applying, the irregular voltage may be generated for a transit period because of resonance or switching. Be sure to use a capacitor within rated voltage containing these irregular voltage.

When DC-rated capacitors are to be used in input circuits from commercial power source (AC filter), be sure to use Safety Recognized Capacitors because various regulations on withstand voltage or impulse withstand established for each equipment should be taken into considerations.



2. OPERATING TEMPERATURE AND SELF-GENERATED HEAT

Keep the surface temperature of a capacitor below the upper limit of its rated operating temperature range. Be sure to take into account the heat generated by the capacitor itself.

When the capacitor is used in a high-frequency current, pulse current or the like, it may have the selfgenerated heat due to dielectric-loss. In case of Class 2 capacitors (Temp.Char. : X7R,X7S,X8L, etc.), applied voltage should be the load such as self-generated heat is within 20 °C on <u>the condition of</u> <u>atmosphere temperature 25 °C</u>. Please contact us if self-generated heat is occurred with Class 1 capacitors (Temp.Char. : C0G,U2J,X8G, etc.). When measuring, use a thermocouple of small thermal capacity-K of ϕ 0.1mm and be in the condition where capacitor is not affected by radiant heat of other components and wind of surroundings. Excessive heat may lead to deterioration of the capacitor's characteristics and reliability.

3. Fail-safe

Be sure to provide an appropriate fail-safe function on your product to prevent a second damage that may be caused by the abnormal function or the failure of our product.

4. OPERATING AND STORAGE ENVIRONMENT

The insulating coating of capacitors does not form a perfect seal; therefore, do not use or store capacitors in a corrosive atmosphere, especially where chloride gas, sulfide gas, acid, alkali, salt or the like are present. And avoid exposure to moisture. Before cleaning, bonding, or molding this product, verify that these processes do not affect product quality by testing the performance of a cleaned, bonded or molded product in the intended equipment. Store the capacitors where the temperature and relative humidity do not exceed 5 to 40 °C and 20 to 70%. Use capacitors within 6 months.

5. VIBRATION AND IMPACT

Do not expose a capacitor or its leads to excessive shock or vibration during use.

6. SOLDERING

When soldering this product to a PCB/PWB, do not exceed the solder heat resistance specification of the capacitor. Subjecting this product to excessive heating could melt the internal junction solder and may result in thermal shocks that can crack the ceramic element.

7. BONDING AND RESIN MOLDING, RESIN COAT

In case of bonding, molding or coating this product, verify that these processes do not affect the quality of capacitor by testing the performance of a bonded or molded product in the intended equipment. In case of the amount of applications, dryness / hardening conditions of adhesives and molding resins containing organic solvents (ethyl acetate, methyl ethyl ketone, toluene, etc.) are unsuitable, the outer coating resin of a capacitor is damaged by the organic solvents and it may result, worst case, in a short circuit.

The variation in thickness of adhesive or molding resin may cause a outer coating resin cracking and/or ceramic element cracking of a capacitor in a temperature cycling.

8. TREATMENT AFTER BONDING AND RESIN MOLDING, RESIN COAT

When the outer coating is hot (over 100 °C) after soldering, it becomes soft and fragile. So please be careful not to give it mechanical stress.

Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used.

9. LIMITATION OF APPLICATIONS

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property.

- 1. Aircraft equipment
- Undersea equipment
 Medical equipment
- 2. Aerospace equipment
- 4. Power plant control equipment
- 6. Transportation equipment (vehicles, trains, ships, etc.)8. Disaster prevention / crime prevention equipment
- 7. Traffic signal equipment
- 9. Data-processing equipment exerting influence on public
- 10. Application of similar complexity and/or reliability requirements to the applications listed in the above.

NOTICE

1. CLEANING (ULTRASONIC CLEANING)

To perform ultrasonic cleaning, observe the following conditions. Rinse bath capacity : Output of 20 watts per liter or less.

Rinsing time : 5 min maximum.

Do not vibrate the PCB/PWB directly.

Excessive ultrasonic cleaning may lead to fatigue destruction of the lead wires.

2. Soldering and Mounting

Insertion of the Lead Wire

- When soldering, insert the lead wire into the PCB without mechanically stressing the lead wire.
- Insert the lead wire into the PCB with a distance appropriate to the lead space.

3. CAPACITANCE CHANGE OF CAPACITORS

• Class 2 capacitors (Temp.Char. : X7R,X7S,X8L, etc.)

Class 2 capacitors an aging characteristic, whereby the capacitor continually decreases its capacitance slightly if the capacitor leaves for a long time. Moreover, capacitance might change greatly depending on a surrounding temperature or an applied voltage. So, it is not likely to be able to use for the time constant circuit.

Please contact us if you need a detail information.

- 1. Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- 2. You are requested not to use our product deviating from this specification.

1. Application

This product specification is applied to Leaded MLCC RDE series used for General Electronic equipment. Do not use these products in any automotive power train or safety equipment including battery chargers for electric vehicles and plug-in hybrids.

2. Rating

Part number configuration

ex.) <u>RDI</u> Serie	E es Temj	R7 perature acteristic	2E Rated voltage	103 Capacitanc	ce K Capacitance tolerance	1 Dimension code	K1 Lead code	H03 Individual specification code	B Packing style code
 Tempe 	Code	aracteristi Temp.		Range	Cap. Change	Standay	d Temp.	Operat	ing
	Code	Char.	iemp.	Trange	(Within%)	Sianuai	u iemp.	Temp.Ra	ange
	R7	X7R	-55~	125°C	+/-15	25	S°C	-55~12	5°C

Rated voltage

Code	Rated voltage
2E	DC250V
2H	DC500V
2J	DC630V
3A	DC1000V

• Capacitance

The first two digits denote significant figures ; the last digit denotes the multiplier of 10 in pF. ex.) In case of 103

 $10 \times 10^3 = 10000 \text{pF}$

• Capacitance tolerance

Code	Capacitance Tolerance
K	+/-10%
М	+/-20%

• Dimension code

Code	Dimensions (LxW) mm max.
1	4.5 x 3.5
2	5.5 x 4.0
3	5.5 x 5.0
4	7.5x 5.5
5	7.5 x 7.5 *
U	7.7 x12.5 *
	*D0000\//D04000\/_\\/_0_5

*DC630V/DC1000V : W+0.5mm

Lead code

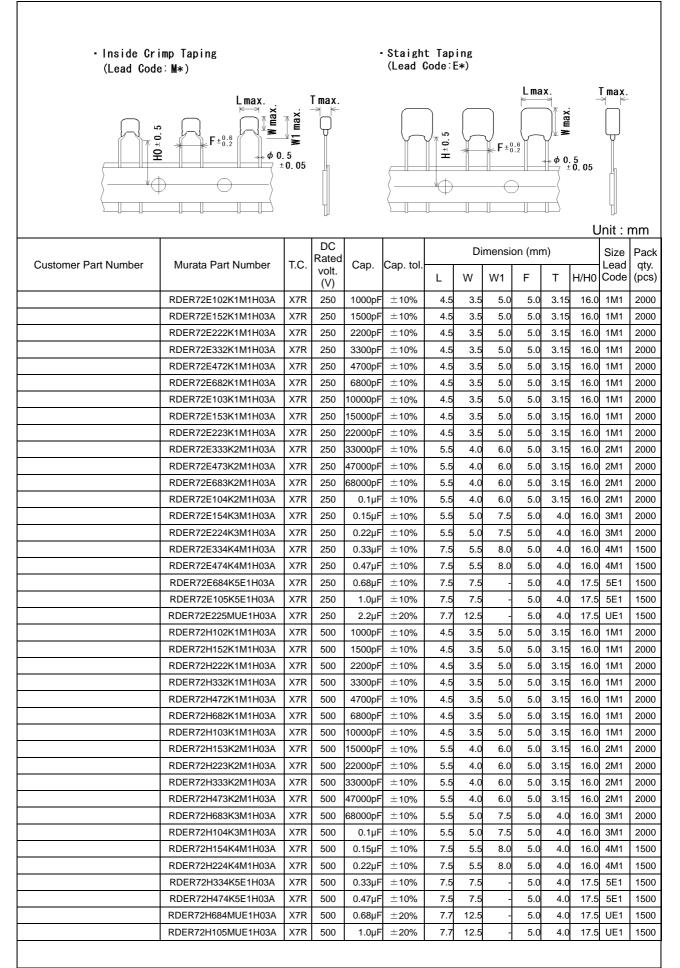
	Code	Lead style	Lead spacing (mm)
ſ	B1	Straight type	5.0+/-0.8
F	E1	Straight taping type	5.0+0.6/-0.2
F	K1	Inside crimp type	5.0+/-0.8
l	M1	Inside crimp taping type	5.0+0.6/-0.2

Lead wire is "solder coated CP wire".

	 Individual specification Murata's Cor Please refer 		ist].		
	Packing style code Code A B	Packing style Taping type of An Bulk type			
3.	Marking				
	Temp. Char. Capacitance Capacitance Tolerat Rated voltage Company name coo (Ex.)	: 3 digit numb nce : Code : Letter code Letter code : Letter code : Letter code :	ers : 4 (DC250V. Exc	ept dimension coc ept dimension cod	le : 1)
	Rated voltage Dimensions	DC250V	DC500V	DC630V	DC1000V
	1	103K	103K		
	2	G ⁴⁷³ K4C	G ¹⁵³ K9C	G ¹⁵³ K7C	(C1 52 KAC
	3, 4	G 154 K4C	(Cm104 K9C	(Cm104 K7C	(Cm473) KAC
	5, U	684 K4C	474 K9C	474 M7C	224 MAC

		etere										
4. Part number list												
 Inside Crimp (Lead Code:K1) 	•Straight L (Lead Code						aight ze Leac	Long d Code:	UB1)			
_		Lma	ax.	T max	κ.			Lm	ax.		Tmax.	
P = 0.8 P = 0.6 P	↔ Ø 0. 5 ± 0. 05	1.5 max.	25.0 min. W max.		≠ 0.5 ±0.05		F±	2.0 max.	25.0 min. W max.	-	→ ¢ 0. ±	. 5 0. 05
										ι	Jnit :	mm
			DC				Dimo	noion /	(mm)			
Customer Part Number	Murata Part Number	T.C.	Rated Volt. (V)	Cap.	Cap. tol.	L	W	nsion (W1	,mm) F	т	Size Lead Code	q
	RDER72E102K1K1H03B	X7R	250	1000pF	±10%	4.5	3.5	5.0	5.0	3.15	1K1	5(
	RDER72E152K1K1H03B	X7R	250	1500pF		4.5	3.5	5.0	5.0	3.15	1K1	50
	RDER72E132K1K1H03B	X7R	250	2200pF		4.5	3.5	5.0	5.0	3.15	1K1	50
	RDER72E332K1K1H03B	X7R	250	3300pF		4.5	3.5	5.0	5.0	3.15	1K1	5
	RDER72E472K1K1H03B	X7R	250	4700pF		4.5	3.5	5.0	5.0	3.15	1K1	5
	RDER72E682K1K1H03B	X7R	250	6800pF		4.5	3.5	5.0	5.0	3.15		5
	RDER72E103K1K1H03B	X7R	250	10000pF		4.5	3.5	5.0	5.0	3.15	1K1	5
	RDER72E153K1K1H03B	X7R	250	15000pF		4.5	3.5	5.0	5.0	3.15	1K1	5
	RDER72E223K1K1H03B	X7R	250	22000pF		4.5	3.5	5.0	5.0	3.15	1K1	5(
	RDER72E333K2K1H03B	X7R	250	33000pF		5.5	4.0	6.0	5.0	3.15	2K1	50
	RDER72E473K2K1H03B	X7R	250	47000pF		5.5	4.0	6.0	5.0	3.15	2K1	50
	RDER72E683K2K1H03B	X7R	250	68000pF		5.5	4.0	6.0	5.0	3.15	2K1	5
	RDER72E104K2K1H03B	X7R	250	0.1µF		5.5	4.0	6.0	5.0	3.15	2K1	5(
	RDER72E154K3K1H03B	X7R	250	0.15µF		5.5	5.0	7.5	5.0	4.0	3K1	5
	RDER72E224K3K1H03B	X7R	250	0.22µF		5.5	5.0	7.5	5.0	4.0	3K1	5
	RDER72E334K4K1H03B	X7R	250	0.33µF		7.5	5.5	8.0	5.0	4.0	4K1	5
	RDER72E474K4K1H03B	X7R	250	0.47µF		7.5	5.5	8.0	5.0	4.0	4K1	5
	RDER72E684K5B1H03B	X7R	250	0.68µF		7.5	7.5	-	5.0	4.0	5B1	5
	RDER72E105K5B1H03B	X7R	250	1.0µF		7.5	7.5	-	5.0	4.0	5B1	5
	RDER72E225MUB1H03B	X7R	250	2.2µF		7.7	12.5	-	5.0		UB1	20
	RDER72H102K1K1H03B	X7R	500	1000pF		4.5	3.5	5.0	5.0	3.15		5
	RDER72H152K1K1H03B	X7R	500	1500pF		4.5	3.5	5.0	5.0		1K1	50
	RDER72H222K1K1H03B	X7R	500	2200pF		4.5	3.5	5.0	5.0		1K1	5
	RDER72H332K1K1H03B	X7R	500	3300pF		4.5	3.5	5.0	5.0		1K1	5
	RDER72H472K1K1H03B	X7R	500		±10%	4.5	3.5	5.0	5.0		1K1	50
	RDER72H682K1K1H03B	X7R	500	6800pF		4.5	3.5	5.0	5.0	3.15		50
	RDER72H103K1K1H03B	X7R	500	10000pF		4.5	3.5	5.0	5.0	3.15		50
	RDER72H153K2K1H03B	X7R	500	15000pF		5.5	4.0	6.0	5.0	3.15		50
	RDER72H223K2K1H03B	X7R	500	22000pF		5.5	4.0	6.0	5.0	3.15		50
	RDER72H333K2K1H03B	X7R	500	33000pF		5.5	4.0	6.0	5.0		2K1	50
	RDER72H473K2K1H03B	X7R	500	47000pF		5.5	4.0	6.0	5.0		2K1	5
	RDER72H683K3K1H03B	X7R	500	68000pF		5.5	5.0	7.5	5.0	4.0		50
	RDER72H104K3K1H03B	X7R	500	0.1µF		5.5	5.0	7.5	5.0	4.0	3K1	5
	RDER72H154K4K1H03B	X7R	500	0.15µF		7.5	5.5	8.0	5.0	4.0		50
	RDER72H224K4K1H03B	X7R	500	0.13µl		7.5	5.5	8.0	5.0	4.0		50
	RDER72H334K5B1H03B	X7R	500	0.22µi		7.5	7.5	5.5	5.0	4.0		50
	RDER72H474K5B1H03B	X7R	500		±10%	7.5	7.5]	5.0	4.0		50
	RDER72H684MUB1H03B	X7R	500	0.47µi 0.68µF		7.7	12.5]	5.0	4.0	UB1	20
	RDER72H105MUB1H03B	X7R	500	0.00μi 1.0μF		7.7	12.5]	5.0	4.0	UB1	20
		111	1 300	1.0µГ	<u> </u>	1.1	12.0	-	J.U	4.0	001	1 21

				oniy								
• Inside Crimp (Lead Code:K1)	•Straight Long (Lead Gode:B1)					• Straig (Size L)			
(Lead Gode KI)		, L max.		Tmax.				L max.)	Tma	X.	
P = 4 P = 0 P	T max.		25.0 min. W max.	⇒ ► ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓	05		.xem 0.2 F ± 0.8		25.0 min. W max.		¢ 0. 5 ± 0. 0	5
										ι	Jnit :	mn
Customer Part Number	Murata Part Number	T.C.	DC Rated	Cap.	Cap.		Dime	nsion	(mm)		Size Lead	Pa qt
		1.0.	Volt. (V)	Cap.	tol.	L	W	W1	F	Т	Code	
	RDER72J102K2K1H03B	X7R	630	1000pF	±10%	5.5	4.0	6.0	5.0	3.15	2K1	50
	RDER72J152K2K1H03B	X7R	630	1500pF	±10%	5.5	4.0	6.0	5.0	3.15	2K1	50
	RDER72J222K2K1H03B	X7R	630	2200pF	±10%	5.5	4.0	6.0	5.0	3.15	2K1	50
	RDER72J332K2K1H03B	X7R	630	3300pF	±10%	5.5	4.0	6.0	5.0	3.15	2K1	50
	RDER72J472K2K1H03B	X7R	630	4700pF	±10%	5.5	4.0	6.0	5.0	3.15	2K1	50
	RDER72J682K2K1H03B	X7R	630	6800pF	±10%	5.5	4.0	6.0	5.0	3.15	2K1	50
	RDER72J103K2K1H03B	X7R	630	10000pF	±10%	5.5	4.0	6.0	5.0	3.15	2K1	50
	RDER72J153K2K1H03B	X7R	630	15000pF	±10%	5.5	4.0	6.0	5.0	3.15	2K1	50
	RDER72J223K2K1H03B	X7R	630	22000pF	±10%	5.5	4.0	6.0	5.0	3.15	2K1	50
	RDER72J333K3K1H03B	X7R	630	33000pF	±10%	5.5	5.0	7.5	5.0	4.0	3K1	50
	RDER72J473K3K1H03B	X7R	630	47000pF	±10%	5.5	5.0	7.5	5.0	4.0	3K1	50
	RDER72J683K4K1H03B	X7R	630	68000pF	±10%	7.5	5.5	8.0	5.0	4.0	4K1	50
	RDER72J104K4K1H03B	X7R	630	0.1µF	±10%	7.5	5.5	8.0	5.0	4.0	4K1	50
	RDER72J154K5B1H03B	X7R	630	0.15µF	±10%	7.5	8.0		5.0	4.0	5B1	50
	RDER72J224K5B1H03B	X7R	630	0.22µF	±10%	7.5	8.0	-	5.0	4.0	5B1	50
	RDER72J474MUB1H03B	X7R	630	0.47µF	±20%	7.7	13.0	-	5.0	4.0	UB1	20
	RDER73A471K2K1H03B	X7R	1000	470pF		5.5	4.0	6.0	5.0	3.15	2K1	50
	RDER73A681K2K1H03B	X7R	1000	680pF	±10%	5.5 5.5	4.0	6.0 6.0	5.0 5.0	3.15	2K1 2K1	50
	RDER73A102K2K1H03B RDER73A152K2K1H03B	X7R X7R	1000 1000	1000pF	±10%	5.5 5.5	4.0 4.0	6.0 6.0	5.0 5.0	3.15 3.15	2K1 2K1	50 50
	-	X7R		1500pF	±10% ±10%							
	RDER73A222K2K1H03B RDER73A332K2K1H03B	X7R	1000 1000	2200pF	±10%	5.5 5.5	4.0 4.0	6.0 6.0	5.0 5.0	3.15 3.15		50 50
	RDER73A332K2K1H03B	X7R	1000	3300pF 4700pF	±10%	5.5	4.0	6.0	5.0	3.15		50
	RDER73A472K2K1H03B	X7R	1000	6800pF		5.5	4.0	6.0	5.0	3.15		50
	RDER73A082K2K1H03B	X7R	1000	10000pF		5.5	4.0	6.0	5.0	3.15	2K1	50
	RDER73A103K2K1H03B	X7R	1000	15000pF		5.5	4.0 5.0	7.5	5.0	4.0	3K1	50
	RDER73A223K3K1H03B	X7R	1000	22000pF	±10%	5.5	5.0	7.5	5.0	4.0	3K1	50
	RDER73A333K4K1H03B	X7R	1000	33000pF	±10%	7.5	5.5	8.0	5.0	4.0	4K1	50
	RDER73A473K4K1H03B	X7R	1000	47000pF	±10%	7.5	5.5	8.0	5.0	4.0	4K1	50
	RDER73A683K5B1H03B	X7R	1000	47000pr 68000pF	±10%	7.5	8.0	0.0	5.0	4.0	5B1	50
	RDER73A104K5B1H03B	X7R	1000	0.1µF		7.5	8.0	_	5.0	4.0	5B1	50
		1	1000	ο. i μi	_ 10/0	1.0	0.0	-	0.0	7.0	501	



 Inside Crimp (Lead Code: N 					aight T ead Cod								
H0+0.5	$F^{\pm 0.6}_{0.2}$		ax. ≮ 			H ± 0.5					T ma	ax. ⊭	
			DC			U		U				Jnit : I	
Customer Part Number	Murata Part Number	T.C.	Rated volt. (V)	Cap.	Cap. tol.	L	Di W	mensi W1	on (mr F	n) T	H/H0	Size Lead Code	Pa qt (pc
	RDER72J102K2M1H03A	X7R	630	1000pF	±10%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	200
	RDER72J152K2M1H03A	X7R	630	1500pF	±10%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RDER72J222K2M1H03A	X7R	630	2200pF	±10%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RDER72J332K2M1H03A	X7R	630	3300pF	±10%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RDER72J472K2M1H03A	X7R	630	4700pF	±10%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RDER72J682K2M1H03A	X7R	630	6800pF	±10%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RDER72J103K2M1H03A	X7R	630	10000pF	±10%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RDER72J153K2M1H03A	X7R	630	15000pF	±10%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RDER72J223K2M1H03A	X7R	630	22000pF	±10%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RDER72J333K3M1H03A	X7R	630	33000pF	±10%	5.5	5.0	7.5	5.0	4.0	16.0	3M1	20
	RDER72J473K3M1H03A	X7R	630	47000pF	±10%	5.5	5.0	7.5	5.0	4.0	16.0	3M1	20
	RDER72J683K4M1H03A	X7R	630	68000pF	±10%	7.5	5.5	8.0	5.0	4.0	16.0	4M1	15
	RDER72J104K4M1H03A	X7R	630	0.1µF	±10%	7.5	5.5	8.0	5.0	4.0	16.0	4M1	15
	RDER72J154K5E1H03A	X7R	630	0.15µF	±10%	7.5	8.0	-	5.0	4.0	17.5	5E1	15
	RDER72J224K5E1H03A	X7R	630	0.22µF	±10%	7.5	8.0	-	5.0	4.0	17.5	5E1	15
	RDER72J474MUE1H03A	X7R	630	0.47µF	±20%	7.7	13.0	-	5.0	4.0	17.5	UE1	15
	RDER73A471K2M1H03A	X7R	1000	470pF	$\pm 10\%$	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RDER73A681K2M1H03A	X7R	1000	680pF	±10%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RDER73A102K2M1H03A	X7R	1000	1000pF	±10%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RDER73A152K2M1H03A	X7R	1000	1500pF	±10%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RDER73A222K2M1H03A	X7R	1000	2200pF	±10%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RDER73A332K2M1H03A	X7R	1000	3300pF		5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RDER73A472K2M1H03A	X7R	1000	4700pF	±10%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RDER73A682K2M1H03A	X7R	1000	6800pF	±10%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RDER73A103K2M1H03A	X7R	1000	10000pF		5.5	4.0	6.0	5.0	3.15			20
	RDER73A153K3M1H03A	X7R	1000	15000pF		5.5	5.0	7.5	5.0	4.0			20
	RDER73A223K3M1H03A	X7R		22000pF		5.5	5.0	7.5	5.0	4.0	16.0		20
	RDER73A333K4M1H03A	X7R		33000pF		7.5	5.5	8.0	5.0	4.0			15
	RDER73A473K4M1H03A	X7R		47000pF		7.5	5.5	8.0	5.0	4.0			15
	RDER73A683K5E1H03A	X7R		68000pF		7.5	8.0	-	5.0	4.0			15
	RDER73A104K5E1H03A	X7R	1000	0.1µF	±10%	7.5	8.0	-	5.0	4.0	17.5	5E1	15

Reference only

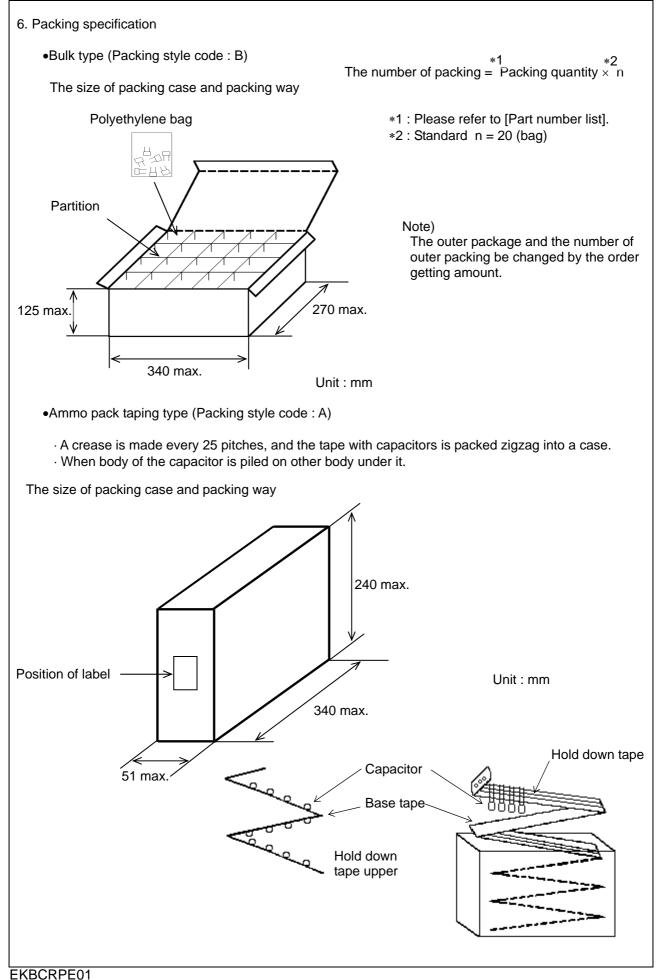
No.	116	em	Specification	Test Method
1	Appearance	9	No defects or abnormalities	Visual inspection.
2		and Marking	Within the specified dimensions and Marking	Visual inspection, Using Caliper.
3	Dielectric Strength	Between Terminals	No defects or abnormalities	The capacitor should not be damaged when voltage in Table is applied between the terminations for 1 to 5 seconds. (Charge/Discharge current ≤ 50mA. Rated voltage Test voltage DC250V 200% of the rated voltag DC500V,DC630V 150% of the rated voltag DC1kV 120% of the rated voltag
		Body Insulation	No defects or abnormalities	The capacitor is placed in a container with metal bal of 1mm diameter so that each terminal, short-circuit is kept approximately 2mm from the balls as shown the figure, for 1 to 5 seconds between capacitor terminals and metal balls. (Charge/Discharge current ≤ 50mA.) Rated voltage Test voltage DC250V, DC500V 200% of the rated voltag DC630V, DC1kV DC1300V
4	Insulation Resistance (I.R.)	Between Terminals	10 000MΩ or 100MΩ· μ F min. (Whichever is smaller)	The insulation resistance should be measured with DC500V (DC250V in case of rated voltage : DC250V) at normal temperature and humidity and within 2 minutes of charging. (Charge/Discharge current is ≤ 50mA)
5	Capacitanc	e	Within the specified tolerance	The capacitance, D.F. should be measured at 25°C at the frequency and voltage shown in the table.
6	Dissipation (D.F.)	Factor	0.025 max.	Char. R7 Item 1±0.1kHz Voltage AC1±0.2Vrms
7	Capacitanc Temperatur Characteris	e	within ±15%	The capacitance change should be measured at each specified temperature stage. Step Temperature(°C) 1 25±2 2 -55±3 3 25±2 4 125±3 5 25±2 • Pretreatment Perform a heat treatment at 150+0/-10°C for one hour and then set at *room condition temperature f 24±2 hours.
8	Terminal Strength	Tensile Strength	Termination not to be broken or loosened	As in the figure, fix the capacitor body, apply the force gradually to each lead in the radial direction of the capacitor until reaching 10N and then keep the force applied for 10±1 seconds.
		Bending Strength	Termination not to be broken or loosened	Each lead wire should be subjected to a force of 2.5N and then be bent 90° at the point of egress in one direction. Each wire is then returned to the original position and bent 90° in the opposite direction at the rate of one bend per 2 to 3 seconds.
9	Vibration	Appearance	No defects or abnormalities	The capacitor should be subjected to a simple
	Kesistance	Capacitance D.F.	Within the specified tolerance 0.025max.	 harmonic motion having a total amplitude of 1.5mm, the frequency being varied uniformly between the approximate limits of 10Hz and 55Hz. The frequency range, from 10Hz to 55Hz and return to 10Hz, shall be traversed in approximately 1 minut This motion shall be applied for a period of 2 hours each 3 mutually perpendicular directions (total of 6 hours).
10	Solderabilit		Solder is deposited on unintermittently immersed portion in axial direction covering 3/4 or more in circumferential direction of lead wires. 35°C, Relative humidity:45 to 75%, Atmosphere	The terminal of capacitor is dipped into a solution of ethanol (JIS K 8101) and rosin (JIS K 5902) (25% rosin in weight propotion). Immerse in solder solutio for 2±0.5 seconds. In both cases the depth of dippir is up to about 1.5 to 2mm from the terminal body. Temp. of solder : 245±5°C Lead Free Solder (Sn-3.0Ag-0.5Cu) 235±5°C H60A or H63A Eutectic Solder

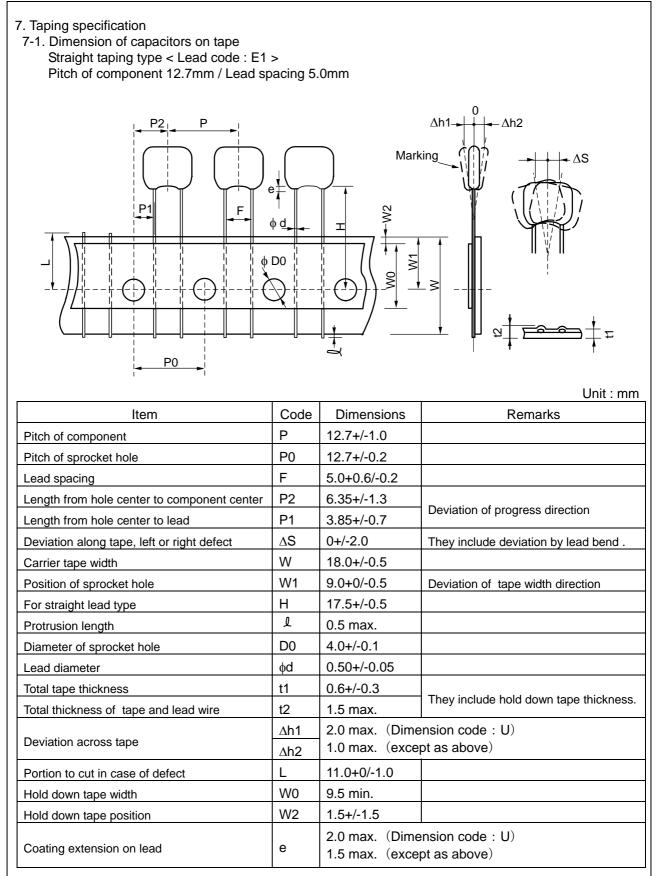
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4.4											
11-1	Resistance to Soldering	Appearance Capacitance	No defects or abnormalities Within ±7.5%	solder 1.5	5 to 2.0mm f	rom the ro	ersed in the m bot of termina				
	Heat (Non- Preheat)	Change Dielectric Strength (Between terminals)	No defects	Pre-trea Capacit hour, th before i • Post-tr	or should be en place at nitial measu reatment or should be	e stored a *room cor irement.	t 150+0/-10°(dition for 24± r 24±2 hours	2 hours			
11-2	Resistance to Soldering	Appearance	No defects or abnormalities		capacitor sh	ould be st	ored at 120+0	0/-5°C fo			
	Heat (On-	Capacitance Change	Within ±7.5%	Then, the	e lead wires		immersed in n the root of to				
	Preheat)	Dielectric Strength (Between terminals)	No defects	260±5°C • Pre-trea Capacit	for 7.5+0/-1 Itment or should be	seconds. e stored a	t 150+0/-10°(dition for 24±	C for on			
4.0	Desistance		No defecto er obnormalitica	 Post-tre Capacit condition 	nitial measu atment or should be n.	rement.	r 24 \pm 2 hours				
1-3	Resistance to Soldering	Appearance Capacitance	No defects or abnormalities Within ±7.5%		ature of iror						
	Heat (soldering	Change			ig time : 3.5	±0.5 seco	nds				
	iron method)	Dielectric Strength (Between terminals)	No defects	Straight Crimp L	Soldering position Straight Lead:1.5 to 2.0mm from the root of termina Crimp Lead:1.5 to 2.0mm from the end of lead ben						
				hour, th before i • Post-tre Capacit conditio	or should be en place at nitial measu atment or should be n.	*room cor rement. e stored fo	t 150+0/-10°0 dition for 24± r 24±2 hours	2 hours at *roo			
12	Temperature Cycle	Appearance	No defects or abnormalities	listed in the	he following	table.	he 4 heat trea				
		Capacitance Change	Within ±12.5%	Set at To		n for 24±2 2	hours, then	measur 4			
		D.F.	0.05 max.	Temp. (°C)	Min. Operating	Room Temp.	Max. Operating	Roon Temp			
		I.R.	1,000MΩ or 50MΩ· μ F min. (Whichever is smaller)	Time (min.)	Temp. ±3 30±3	3 max.	Temp. ±3 30±3	3 max			
		Dielectric Strength (Between Terminals)	No defects or abnormalities	Pretreat Perform	a heat trea		50+0/-10°C f ondition for 24				
13	Humidity (Steady	Appearance	No defects or abnormalities		apacitor at 4 90 to 95% fo						
	State)	Capacitance Change	Within ±12.5%		and set at *r		lition for 24±2	hours,			
		D.F.	0.05 max.	Pretreat	ment						
		I.R.	1,000MΩ or 50MΩ·μF min. (Whichever is smaller)	Perform	a heat trea		50+0/-10°C f				
		Marking	Legible	hours.							
14	Humidity Load	Appearance	No defects or abnormalities	humidity	of 90 to 95%	6 for 500+	°C and relative 24/-0 hours.				
		Capacitance Change	Within ±12.5%	Remove a then mea	and set at *r sure.	oom conc	lition for 24±2	hours,			
		D.F.	0.05 max.		Discharge c	urrent ≤ 50)mA)				
		I.R.	500MΩ or 25MΩ·μF min. (Whichever is smaller)		a heat trea		50+0/-10°C f andition for 24				
ʻroom	condition" Tem	perature:15 to	I 35°C, Relative humidity:45 to 75%, Atmosp		106kPa						

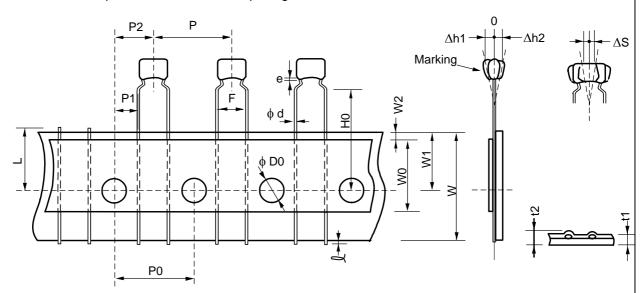
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lo. 15	lto	em	Specification	Test Method
י רו	High	Appearance	No defects or abnormalities	Apply voltage in Table for 1000+48/-0 hours at the
5	Temperature	, ppcardiice		maximum operating temperature $\pm 3^{\circ}$ C.
	Load	Capacitance	Within ±12.5%	Remove and set at *room condition for 24±2 hours
		Change		then measure.
		D.F.	0.04 max.	(Charge/Discharge current ≤ 50mA)
		I.R.	1,000MΩ or 50MΩ·μF min.	Rated voltage Test voltage
		I.K.	(Whichever is smaller)	DC250V 150% of the rated voltag
				DC500V,DC630V 120% of the rated voltag DC1kV 110% of the rated voltag
				 Pretreatment Apply test voltage for one hour at test temperatur
				Remove and set at *room condition for 24±2 hou
	Solvent	Appearance	No defects or abnormalities	The capacitor should be fully immersed, unagitated
	Resistance			in reagent at 20 to 25°C for 30±5 sec. and then
		Marking	Legible	remove gently. Marking on the surface of the capacitor shall immendiately be visually examined.
				Regent : Isopropyl alcohol
oom	condition" Tem	perature:15 to	35°C, Relative humidity:45 to 75%, Atmosph	here pressure:86 to 106kPa



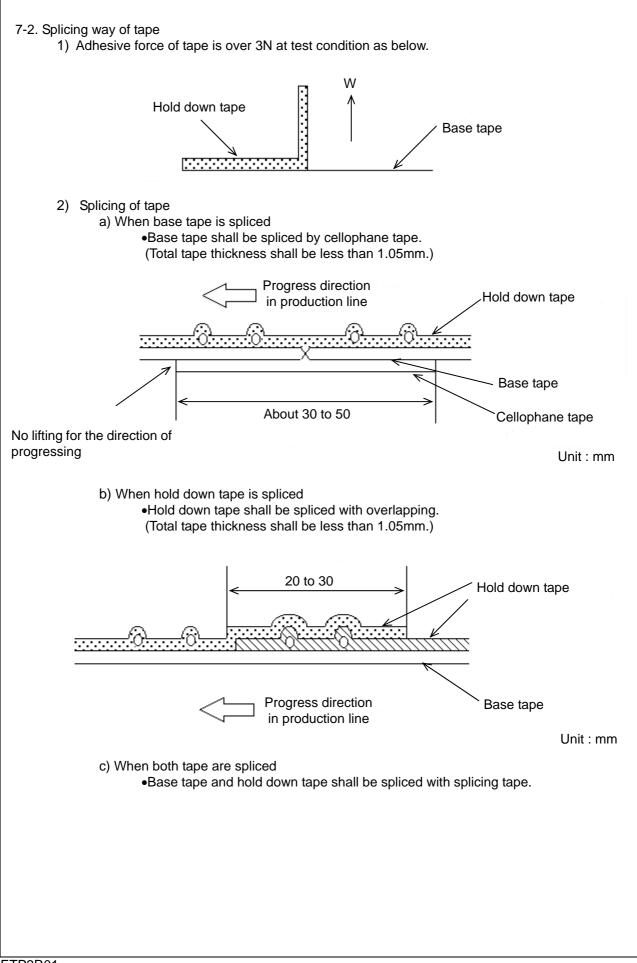


Inside crimp taping type < Lead code : M1 > Pitch of component 12.7mm / Lead spacing 5.0mm



Unit : mm

Item	Code	Dimensions	Remarks	
Pitch of component	Р	12.7+/-1.0		
Pitch of sprocket hole	P0	12.7+/-0.2		
Lead spacing	F	5.0+0.6/-0.2		
Length from hole center to component center	P2	6.35+/-1.3	Deviation of progress direction	
Length from hole center to lead	P1	3.85+/-0.7		
Deviation along tape, left or right defect	ΔS	0+/-2.0	They include deviation by lead bend .	
Carrier tape width	W	18.0+/-0.5		
Position of sprocket hole	W1	9.0+0/-0.5	Deviation of tape width direction	
Lead distance between reference and bottom plane	HO	16.0+/-0.5		
Protrusion length	l	0.5 max.		
Diameter of sprocket hole	D0	4.0+/-0.1		
Lead diameter	φd	0.50+/-0.05		
Total tape thickness	t1	0.6+/-0.3	They include hold down tape thickness.	
Total thickness of tape and lead wire	t2	1.5 max.		
Deviation across tape	∆h1	2.0 max. (Dime	ension code : W)	
	∆h2	1.0 max. (except as above)		
Portion to cut in case of defect	L	11.0+0/-1.0		
Hold down tape width	W0	9.5 min.		
Hold down tape position	W2	1.5+/-1.5		
Coating extension on lead	е	Up to the end of crimp		



EU RoHS and Halogen Free

This products of the following crresponds to EU RoHS and Halogen Free

(1) RoHS

EU RoHs 2011/65/EC compliance

maximum concentration values tolerated by weight in homogeneous materials •1000 ppm maximum Lead

- •1000 ppm maximum Mercury
- •100 ppm maximum Cadmium
- •1000 ppm maximum Hexavalent chromium
- •1000 ppm maximum Polybrominated biphenyls (PBB)
- •1000 ppm maximum Polybrominated diphenyl ethers (PBDE)

(2) Halogen-Free

The International Electrochemical Commission's (IEC) Definition of Halogen-Free (IEC 61249-2-21) compliance

- •900 ppm maximum chlorine
- •900 ppm maximum bromine
- •1500 ppm maximum total chlorine and bromine

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